

PTC

Product Clas	s Overcurrent Protection Telecom, Leaded disk B59xxxC/U* (Cu) 14.10.2019							
Date								
IMDS ID if available								
Version	5.07		-					
Product Part (IMDS: semi component)	Material Class (IMDS: Material)	Material (Classification) VDA 231	Substance	TMPS**) [wt%]	CAS if applicable	typical mass of material [wt-%]	Traces see 1)	
Active Part	Ceramic	3B	Ba-titanates Pb-titanates Sr-titanates Ca-titanates others*)	68 16 11 4 1	12047-27-7 12060-00-3 12060-59-2 12049-50-2	80.98		
Termination	Noble Metal	1D7 1C14	Ag or Cu	100 100 100	7440-22-4 7440-50-8	0.12		
	Heavy Metal Heavy Metal	1C14 1C2	Ni Cr	100	7440-02-0 7440-47-3	0.06		
Solder	Heavy Metal	1C15	Pb +) Sn Ag	93 5 2	7439-92-1 7440-31-5 7440-22-4	7.2		
Leads	Heavy Metal	1C12	Cu	100	7440-50-8	6.5		
	Heavy Metal	1C8	Sn	100	7440-31-5	0.3		
Encapsulation	Organic, solid	4B1	Silicone Lacquer	100		4.8		
					Sum of total	100		
size [mm] 11 x 4 5,6 x 4 3 x 5,5 Not part of a Produ	weight range [g] 1,1 0,72 1,0 ct Class	material numbers B59063C1105B15 B59076C1120A15 B59173C1150A15	1 1	size [mm] 9 x 4,5				
Contact	Ronner Christoph Important remarks:							
Division	PPD Q QM 1) The declaration limit is 0.1% as defined by IEC 62474 (IEC PAS 61906). Trace:						906). Traces are	
Address	8530 Deutschlandsbe	rg, AUSTRIA		product parts, subs	product parts, substances etc. that are below a percentage of 0.1 % by weight, if not otherwise			
	Tel: +43 3462 800 2139	mailto: functional.ppd-eqpm.db(regulated. 2) This Material Data Sheet contains typical values of the respective products set forth herein. We expressly point out that all values and statements contained herein are based on of					
**) typical mass perc	rable or prohibited substa entage of substance date list of Substances of 0006/EC		. to	best present knowledge and cannot be regarded as binding statements or binding product specifications, unless otherwise explicitly agreed in writing. TDK ELECTRONICS AG AND ITS AFFILIATES HEREBY EXPRESSLY DISCLAIM ANY REPRESENTATION OR WARRANTY, WHETHER EXPRESS, IMPLIED OR STATUTORY, WITH REGARD TO THE STATEMENTS AND VALUES CONTAINED HEREIN, INCLUDING BUT NOT LIMITED TO ANY REPRESENTATION OR WARRANTY OF MERCHANTABILITY OR SUITABILITY FOR ANY PURPOSE.				
		•	atible means that products ar ne restriction of the use of cer	e compatible with the requ	•	· · · · · · · · · · · · · · · · · · ·	Directive 2011/65/EL	
 no exemptions; Exemption 6 (a): Exemption 6 (b): Exemption 6 (c): Exemption 7 (a): 	Lead as an alloying element Lead as an alloying element Copper alloy containing up to Lead in high melting tempera	in steel for machining purpo in aluminium containing up o 4 % lead by weight; ature type solder (i.e. lead-b	Annex III: (I valid I not v uses and in galvanized steel contai to 0,4 % lead by weight; ased alloys containing 85 % by we a glass or ceramic other than diele	ning up to 0,35 % lead by weig ight or more lead);		lass or ceramic matrix compoun	d;	
 Exemption 7 (c)-III: Exemption 15: 	Lead in dielectric ceramic in	capacitors for a rated voltag a viable electrical connection	e of 125 V AC or 250 V DC or high e of less than 125 V AC or 250 V I n between semiconductor die and o	DC;	Flip Chip packages;			